onsemi

Quad 2-Input AND Gate MM74HCT08

General Description

The MM74HCT08 is a logic function fabricated by using advanced silicon–gate CMOS technology which provides the inherent benefits of CMOS — low quiescent power and wide power supply range. This device is input and output characteristic and pinout compatible with standard 74LS logic families. All inputs are protected from static discharge damage by internal diodes to V_{CC} and ground.

MM74HCT devices are intended to interface between TTL and NMOS components and standard CMOS devices. These parts are also plug-in replacements for LS-TTL devices and can be used to reduce power consumption in existing designs.

Features

- TTL, LS Pin-out and Threshold Compatible
- Fast Switching: t_{PLH}, t_{PHL} = 9 ns (Typ.)
- Low Power: 10 µW at DC
- High Fan-out, 10 LS-TTL Loads
- This Device is Pb-Free and Halide Free

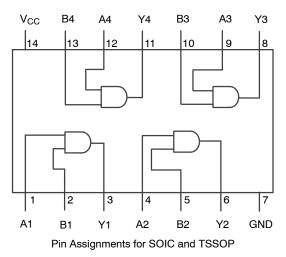


Figure 1. Connection Diagram

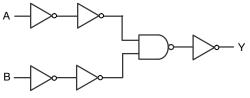
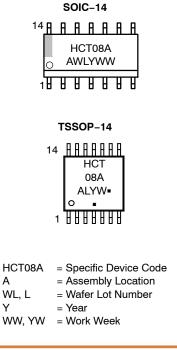


Figure 2. Logic Diagram





ORDERING INFORMATION

See detailed ordering and shipping information on page 4 of this data sheet.

ABSOLUTE MAXIMUM RATINGS (Note 1)

Symbol	Rating	Min	Max	Unit	
V_{CC}	Supply Voltage	-0.5	+7.0	V	
V _{IN}	DC Input Voltage		-0.5	V _{CC} + 0.5	V
V _{OUT}	DC Output Voltage	-0.5	V _{CC} + 0.5	V	
I _{IK} , I _{OK}	Clamp Diode Current		±20	mA	
I _{OUT}	DC Output Current, per pin		±25	mA	
I _{CC}	DC V_{CC} or GND Current, per pin		±50	mA	
T _{STG}	Storage Temperature Range	-65	+150	°C	
PD	Power Dissipation SOIC Package only			500	mW
ΤL	Lead Temperature (Soldering 10 second)		260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Unless otherwise specified all voltages are referenced to ground.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Max	Unit
V _{CC}	Supply Voltage		5.5	V
V _{IN} , V _{OUT}	DC Input or Output Voltage	0	V _{CC}	V
T _A	Operating Temperature Range	-55	+125	°C
t _r , t _f	Input Rise or Fall Times	-	500	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

MM74HCT08

	Parameter	Conditions	TA	= 25°C	T _A = −40 to 85°C	T _A = −55 to 125°C	
Symbol			Тур		Guaranteed Limits		
V _{IH}	Minimum HIGH Level Input Voltage			2.0	2.0	2.0	V
VIL	Maximum LOW Level Input Voltage			0.8	0.8	0.8	V
V _{OH}	Minimum HIGH Level Output Voltage	V_{IN} = V_{IH} or V_{IL} , $ I_{OUT} $ = 20 μ A	V _{CC}	V _{CC} – 0.1	V _{CC} – 0.1	V _{CC} – 0.1	V
		$ \begin{array}{l} V_{IN} = V_{IH} \text{ or } V_{IL}, \\ I_{OUT} = 4.0 \text{ mA}, \\ V_{CC} = 4.5 \text{ V} \end{array} $	4.2	3.98	3.84	3.7	
			5.2	4.98	4.84	4.7	
V _{OL}	Maximum LOW Level Voltage	V_{IN} = V_{IH} or V_{IL} , $ I_{OUT} $ = 20 μ A	0	0.1	0.1	0.1	V
		$ \begin{aligned} & V_{IN} = V_{IH} \text{ or } V_{IL}, \\ & I_{OUT} = 4.0 \text{ mA}, \\ & V_{CC} = 4.5 \text{ V} \end{aligned} $	0.2	0.26	0.33	0.4	
		$ \begin{aligned} & V_{IN} = V_{IH} \text{ or } V_{IL}, \\ & I_{OUT} = 4.8 \text{ mA}, \\ & V_{CC} = 5.5 \text{ V} \end{aligned} $	0.2	0.26	0.33	0.4	
I _{IN}	Maximum Input Current	$V_{IN} = V_{CC}$ or GND, V_{IH} or V_{IL}		±0.1	±1.0	±1.0	μA
I _{CC}	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0 \ \mu A$		2.0	20	40	μA
		V _{IN} = 2.4 V or 0.5 V (Note 2)		1.2	1.4	1.5	mA

DC ELECTRICAL CHARACTERISTICS ($V_{CC} = 5 V \pm 10\%$, unless otherwise specified)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. This is measured per input with all other inputs held at V_{CC} or ground.

AC ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0 \text{ V}$, $t_r = t_f = 6 \text{ ns}$, $C_L = 15 \text{ pF}$, $T_A = 25^{\circ}\text{C}$)

Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Unit
t _{PLH} , t _{PHL}	Maximum Propagation Delay		9	15	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS (V_{CC} = 5.0 V \pm 10%, t_r = t_f = 6 ns, C_L = 50 pF)

			TA	= 25°C	T _A = −40 to 85°C	T _A = −55 to 125°C	
Symbol	Parameter	Conditions	Тур	Guaranteed Limits		Unit	
t _{PLH} , t _{PHL}	Maximum Propagation Delay		11	18	23	27	ns
t _{THL} , t _{TLH}	Maximum Output Rise and Fall Time		7	15	19	22	ns
C _{PD}	Power Dissipation Capacitance	(Note 3)	38				pF
C _{IN}	Input Capacitance		5	10	10	10	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.

MM74HCT08

ORDERING INFORMATION

Device	Package	Shipping [†]
MM74HCT08M	SOIC-14 NB, Case 751A-03 (Pb-Free and Halide Free)	55 Units / Tube
MM74HCT08MX	SOIC 14, Case 751EF (Pb-Free and Halide Free)	2500 Units / Tape & Reel
MM74HCT08MTC	TSSOP-14 WB, Case 948G-01	96 Units / Tube
MM74HCT08MTCX	(Pb-Free and Halide Free)	2500 Units / Tape & Reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

NOTE: All packages are lead free per JEDEC: J-STD-020B standard.

DUSEM

0.068

0.019

0.344

0.244



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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SOIC-14 CASE 751A-03 ISSUE L

DATE 03 FEB 2016

STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 9. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
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SOIC14 CASE 751EF **ISSUE O** DATE 30 SEP 2016 8.75 8.50 Α 0.65 7.62 14 8 14 8 В 4.00 6.00 5.60 3.80 Ħ 1.70 7 **PIN #1** 1,27 7 0.51 **IDENT.** 1.270.35 (0.33) \oplus 0.25 (M) С В Α LAND PATTERN RECOMMENDATION TOP VIEW 1.75 MAX 0.25 С 0.19 0.10 С 1.50 0.25 0.10 1.25 SIDE VIEW **FRONT VIEW** NOTES: A. CONFORMS TO JEDEC MS-012, VARIATION AB, ISSUE C **B. ALL DIMENSIONS ARE IN MILLIMETERS** 0.50 0.25 × 45° C. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS LAND PATTERN STANDARD: R0.10 GAGE D. SOIC127P600X145-14M PLANE R0.10 E. CONFORMS TO ASME Y14.5M, 2009 0.36 8° 0° 0.90 0.50 SEATING PLANE (1.04)DETAIL A SCALE 16 : 1 Electronic versions are uncontrolled except when accessed directly from the Document Repository. DOCUMENT NUMBER: 98AON13739G Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. **DESCRIPTION:** SOIC14 PAGE 1 OF 1

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